

HDMI 1.4b 1:2 Splitter/Demux for 3.4Gbps Data Rate with Equalization & Pre-emphasis

Features

- Support up to 3.4Gbps TMDS Serial Link Compliant with HDMI 1.4b requirement
- HDMI 1-to-2 Splitter or 1-to-2 DeMux with Equalization & Pre-emphasis up to 340 MHz Clock
- · AC or DC Coupled Differential Signaling Input
- Configurable TMDS Output Signal with Port Selection, Pre-emphasis, Voltage Swing, Slew Rate Control
- Support Squelch Mode with Built-in Clock detector
- Control Status Register controlled by Pin strap or I²C mode programming
- ESD Protection on I/O pins to connector: 8KV Contact per IEC6100-4-2 and 2KV HBM
- Supply Voltage: 3.3V
- Industrial Temperature Range: -40°C to 85°C
- Packaging (Pb-free & Green): 56-contact TQFN (ZB56)

VDD D0P1 D0N1 GND D2P D2N VDD CLKP1 CLKN1 PI3HDX412BD D1F TOFN-56 D1N D2P2 D0P D2N2 D0N 10 11 VDD D1P2 VDD VDD L_OUT T_SEL VDD18 CTL GND VDD CRND CLKNZ CLKNZ CLKNZ CLKNZ CLKNZ CLKNZ CLKNZ COND

PI3HDX412BD Package & Pinout

General Description

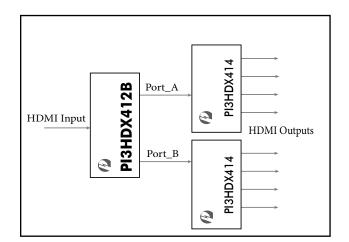
Pericom Semiconductor's PI3HDX412BD, active-drive switch solution is targeted for high-resolution video networks that are based on HDMITM/DVI standards, and TMDS signal processing.

The PI3HDX412BD is an active single TMDS channel to two TMDS channel Splitter and DeMux with Hi-Z outputs. The device drives differential signals to multiple video display units.

It provides controllable output swing levels that can be controlled through pin control or I2C control, depending on the mode select pin. This solution also provides a unique advanced pre-emphasis technique to increase rise and fall times.

The maximum HDMITM/DVI data rate of 3.4Gbps provides a 1920x1080 @60Hz resolution or 4K @30Hz required for 4K HDTV and PC graphics products. Due to its active unidirectional feature, this switch is designed for usage only for the video driver's side. For PC graphics application, the device sits at the driver's side to switch between multiple display units, such as PC LCD monitor, projector, TV, etc.

PI3HDX412BD ensures transmitting high bandwidth video streams from PC graphics source to end display units. It will also provide enhanced robust ESD/EOS protection, which is required by many consumer video networks today.



Application Block Diagram

TMDS In/Out Pin Assignment

Pin #	Pin Name	Туре	Description				
4	D2P	I					
5	D2N	I	Input Port. TMDS Clock and Data Input pins. When Input Terminati Resistor (Rt = 50 Ohm) tied to VDD or GND, Rpd=200 kOhm shall b "OFF" state. I2C registers can control Rt and Rpd ON/OFF state.				
7	D1P	I	Input Port. TMDS Clock and Data Input pins. When Input Termination				
8	D1N	I	Resistor (Rt = 50 Ohm) tied to VDD or GND, Rpd=200 kOhm shall be				
9	D0P	I					
10	D0N	I	I2C registers can control Rt and Rpd ON/OFF state.				
12	CLKP	I					
13	CLKN	I					
25	CLKN2	О					
26	CLKP2	О					
28	D0N2	О					
29	D0P2	О	Output Port 1. TMDS Clock and Data Output pins. ROUT_SEL pin en-				
31	31 D1N2 O						
32							
34	D2N2	О					
35	D2P2	О					
37	CLKN1	О					
38	CLKP1	О					
40	D0N1	0					
41	D0P1	О	Output Port 2. TMDS Clock and Data Output pins. ROUT_SEL pin en-				
43			ables Output Termination Resistor (Rout=50 Ohm).				
44							
46	D2N1	О					
47	D2P1	О					

Note: In TMDS Data and Clock Differential Pair, the polarity +/- (or P/N) of each pair can use interchangeably. When input TMDS Input Clock polarity +/- pin swaps, output TMDS Clock of port 1 and port 2 shall swapped accordingly.

PI3HDX412BD



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Control Pins

Pin#	Pin Name	Type	Description				
			Mode Selection Pin. Internal pull-up at 100K Ohm.				
1	MS	I	"High" : I ² C Con	trol Mode Selectio	on		
			"Low": Pin Con	trol Mode Selectio	n		
			Bus specification Pin#1 MS sets "H Pin#1 MS sets "L Internally Pull-U	2 pin or I ² C Clock a, up to 400 Kbps. High": Pin#19 assig ow": Pin#19 assig p at 100 Kohm an	gns to SCL_CTL p ns to EQ2 pin d Pull-Down at 10	00 Kohm.	
19	EQ2/SCL CTL		Thi Condo EQ	EQ2 (Pin# 19)	EQ1	Equalization Setting (dB)	
20	EQ1/SDA_CTL	IO	Pin#1 MS = "Low"	0	(1 III# 20) M	2.5	
				0	0	5	
				M	0	7.5	
				0	1	10	
				M	M	12.5	
				1	0	15	
				1	M	17.5	
				1	1	20	
49 50 51 52	SW1/I2C_ADR0 SW2/I2C_ADR1 EMP1/I2C_ADR2 EMP2/I2C_ADR3	I	Shared Pin. SW or EMP or I2C_ADR pins. When Pin#1 MS="High": These Shared Pins assign to I2C_ADR[3:0] When Pin#1 MS="Low": These Shared Pins assign to SW1/2 and EMP? These SW2 and SW1 pins control output voltage swing adjustment as ft table. These SW pins have internal Pull-Up 100K Ohm. SW2 (Pin#50) SW1 (Pin#49) Output Voltage Swing				
			0	0	500 mV		
			0	0	-10 % +10 %		
			1	1	+10 %		

Pin#	Pin Name	Type	Description					
			EMP2 and EMP1 pins control output voltage pre-emphasis. These pins have internally Pull-Up 100 Kohm.					
49			EMP2 (Pin#52)	EMP1 (Pin#51)	Pre-emphasis Setting (dB)			
50	(Continued)	I	0	0	0			
51			0	1	1.5			
52			1	0	2.5			
			1	1	3.5			
56	OF	1	Output Enable Co	-	lly pull-up at 100 Kohm.			
56	OE	I	"Low": Turn off Rout and Rt(termination resistor). TMDS Receiver and TM Output Drivers are "OFF" state.					
54	DR	I	Direction Control pin "High": All ports are Active at same time "Low": Output Ports are controlled by SEL1 (Pin#55) control					
55	SEL1	I	Port 1 or Port 2 Output Enable Selection pin. Internal pull-up at 100 Kohm. "High": Enable Output Port 2 "Low": Enable Output Port 1					
16	SEL_OUT	O	SEL_OUT pin. I^2C Register Offset $0x00$ Bit[5] can control this pin status. Offset $0x00$ Bit[5] ="1": Enable Output Port 1 Output Offset $0x00$ Bit[5] ="0": Disable Output Port 1 Output					
17	ROUT_SEL	I	"High" : Source Te	ermination Outpu	nternal pull-up at 100K Ohm. It (Rout) Resistor is "ON", connect to VDD in (Rout) Resistor is "OFF". Open-Drain Output			

PI3HDX412BD



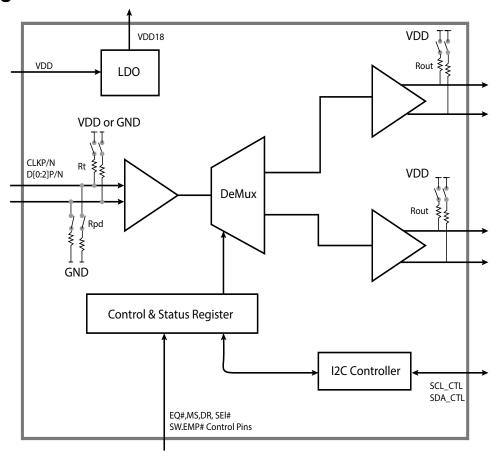
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Power/Ground Pins

Pin #	Pin Name	Type	Description
18	VDD18	Power	LDO Output Pin for internal core supplier. Add external 4.7 uF capacitor to GND
3,14,21,23,27,33,39,45,53	GND	Ground	Ground Pins
2,6,11,15,24,30,36,42,48	VDD	Power	3.3V Power Supply



Block Diagram





Squelch Mode:

Output Disable (Squelch) Mode uses TMDS Clock channel signal detection. When low voltage levels on the TMDS input clock signals are detected, Squelch state enables and TMDS output port signals shall disable; when the TMDS clock input signal levels are above a pre-determined threshold voltage, output ports shall return to the normal voltage swing levels.

When enable Squelch mode, input termination resistor will be enabled together. When Squelch is disabled through I2C register programming RX_SET[1]="1" and no TMDS input signal condition, TMDS D[0:2]P/N will be undetermined status. In Squelch state, TMDS output is high impedance state or TMDS output port shall 50 Ohm pull-up at source termination output.

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Function Control Table

OE	MS	DR	SEL1	HDMI Outputs			
0	X	X	X	All Port Disable			
Pin Cotro	ol Mode						
1	0	1	X	All Ports Enable			
1	0	0	0	Enable Port 1			
1	0	0	1	Enable Port 2			
I2C Cont	rol Mode						
1	1	x	x	I2C Programming Mode			



I²C Register Control Programming

I²C Register Control

Pin Name	I/O	Description
SCL_CTL	I	I2C Clock, compatible with I2C-bus specification, up to 400 kb/s
SDA_CTL IO I2C Data, compatible with I2C-bus specification, up to 400 kb/s		I2C Data, compatible with I2C-bus specification, up to 400 kb/s
I2C_ADR[3:0]	I	I2C Control Address Setting
Byte output : 0x00 - 0x07	О	I2C Control registers output

I²C Address Byte

	b[7] MSB	b[6]	b[5]	b[4]	b[3]	b[2]	b[1]	b[0] (R/W)
Address Byte	1	0	1	A3	A2	A1	A0	1/0*

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Note: Read "1", Write "0"



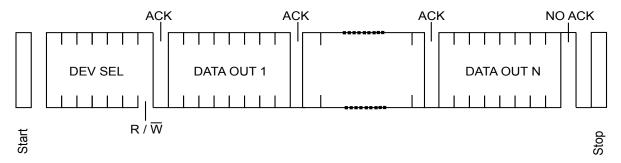
Offset	Name	Description	Power Up Condition	Туре
0x00	CONFIG[7:0]	 [7] Enable TMDS Standby mode. In standby mode, TMDS equalizer and output driver shall power down. "0": Standby mode "1": Normal mode [6] Reserved [5] Output TMDS Port 1 Select "0": Disable "1": Enable [4] Output TMDS Port 2 Selected "0": Disable "1": Enable [3] Reserved [2:0] Reserved 	0xFF	R/W
		TMDS Receiver Equalization Setting Registers [7] Disable Input Port input termination resistors "0": Enable Rpd connection "1": Disable Rpd connection [6] TMDS Input termination V-bias selection "0": Connect to GND "1": Connect to VDD [5] V-bias register selection enable "0": bit[6] control disable "1": bit[6] control enable [4:2] EQ programmable setting		
0x01	RX_SET[7:0]	b[4:2] EQ Setting (dB) 000 2.5 001 5 010 7.5 011 10 100 12.5 101 15 110 17.5 111 20 [1] Squelch Control Bit "0": Squelch enable "1": Squelch disable [0] Reserved	0x00	R/W
0x02	Reserved	[7:0] Reserved	0x00	R/W



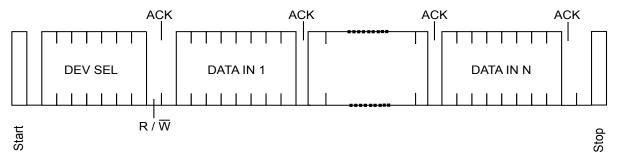
Offset	Name	Description	Power Up Condition	Туре
0x03	TX_SET[7:0] for port1	TMDS Port 1 Output setting [7] TMDS output control "0": Open drain "1": Double termination [6:4] TMDS output Pre-emphasis control "000": 0 dB "001": 1.5 dB "010": 2.5 dB "011": 3.5 dB "1xx": 6 dB (750 mVpp swing) [3:2] TMDS output swing setting "00": 500 mV as default "01": -10% "10": +10% "11": +20% [1:0] TMDS output slew rate setting "00": as default "00": +5%	0x00	R/W
		"11": +10% TMDS Port 2 Output setting [7] TMDS output control "0": Open drain "1": Double termination [6:4] TMDS output Pre-emphasis control "000": 0 dB "001": 1.5 dB "010": 2.5 dB "011": 3.5 dB		
0x04	TX_SET[7:0] for port2	"1xx": 6 dB (750 mVpp swing) [3:2] TMDS output swing setting "00": 500 mV as default setting "01": -10% "10": +10% "11": +20% [1:0] TMDS output slew rate setting "00": Default setting "01" / "10": +5% "11": +10%	0x00	R/W
0x05	Reserved	[7:0] Reserved	0x00	R/W
0x06	Reserved	[7:0] Reserved	0x0F	R/W
0x07	Reserved	[7:0] Reserved	0x00	R/W

I²C Data Transfer

1. Read Sequence



2. Write Sequence





Absolute Maximum Ratings

Supply Voltage to Ground Potential	4.5V
DC SIG Voltage	\dots -0.5V to V_{DD} +0.5V
Storage Temperature	65°C to +150°C
Operating Temperature	40 to +85°C

Note:

Stresses greater than those listed under MAXIMUM RAT-INGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

Thermal Characteristics

Symbol	Parameter	Ratings	Units
T_{Jmax}	Junction Temperature	125	°C
$R_{ heta JC}$	Thermal Resistance, Junction to Case	5	°C/W
R _{0JA}	Thermal Resistance, Junction to Ambient	24	

Electrical Characteristics T_J=25 °C unless otherwise noted

DC Specifications VDD=3.3V +/- 10%

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
V_{DD}	Operation Voltage		3.0	3.3	3.6	V
I_{DD}	VDD Supply Current			250	290	mA
I_{DDQ}	VDD Quiescent Current	OE = 1, No input signal		50	80	mA
I_{STB}	Standby mode	OE = 0		1	5	mA
TMDS Diffe	erential Pins					
V _{OH}	Single-ended high level output voltage	VDD = 3.3 V, Rout=50 Ω	VDD-10		VDD+10	mV
VOL	Single-ended low level output voltage		VDD-600		VDD-400	mV
Vswing	Single-ended output swing voltage		400		600	mV
VOD(O)	Overshoot of output differential voltage				180	mV
VOD(U)	Undershoot of output differential voltage				200	mV
VOC(SS)	Change in steady-state common- mode output voltage between logic states				5	mV
IOS	Short Circuit output current		-12		12	mA
IOS	Short Circuit output current at double termination mode		-24		24	mA

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Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
VI(open)	Single-ended input voltage under high impedance input or open input	IL = 10 uA	VDD-10		VDD+10	mV
RT	Input termination resistance	VIN = 2.9 V	45	50	55	Ohm
IOZ	Leakage current with Hi-Z I/O	VDD = 3.6 V, OE = 0		30	100	μΑ
Control pins (OE, SEL1, EMP2, EMP1, SW2, SW1, MS)						
I_{IH}	High level digital input current	V _{IH} =V _{DD}	-10		10	μA
I_{IL}	Low level digital input current	$V_{IL} = GND$	-50		10	μA
V_{IH}	High level digital input voltage		2.4			V
V_{IL}	Low level digital input voltage		0		0.8	V

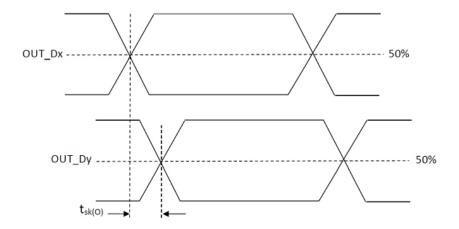
AC Specifications

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
tpd	Propagation delay				2000	ps
t _r	Differential output signal rise time (20% - 80%), 0 dB / Open drain	VDD=3.3V, ROUT=50 ohm		117		ps
t_{f}	Differential output signal fall time (20% - 80%), 0 dB / Open drain			117		ps
t _{sk(p)}	Pulse skew			15	50	ps
$t_{sk(D)}$	Intra-pair differential skew			25	50	ps
$t_{sk(O)}$	Inter-pair differential skew				100	ps
t_{sx}	Select to switch output				550	ns
t _{en}	Enable time			1	10	us
t _{dis}	Disable time				50	ns
tjit_clk(pp)	Peak-to-peak output jitter CLK residual jitter	Data: 3.4 Gbps data pattern		10		ps
tjit_data(pp)	Peak-to-peak output jitter Date residual jitter	Clock: 340 MHz		28		ps

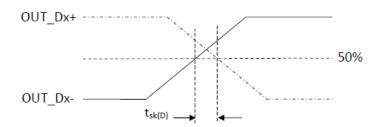
^{1.} Overshoot of output differential voltage $V_{OD(O)}$ = $(V_{SWING(MAX)}$ *2) * 15% 2. Undershoot of output differential voltage $V_{OD(O)}$ = $(V_{SWING(MIN)}$ *2) * 25%



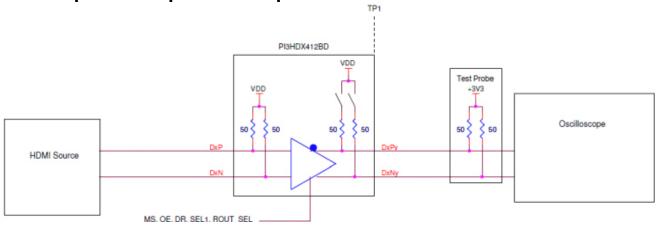
Inter-pair Skew Definition



Intra-pair Skew Definition

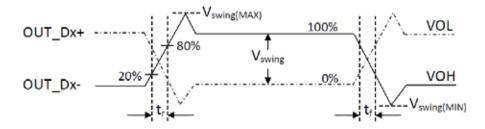


Test Setup of DC-coupled TMDS Input Measurement

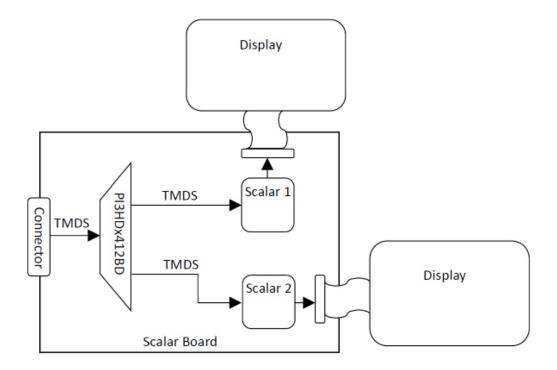




Rise/Fall Time and Single-ended Swing Voltage



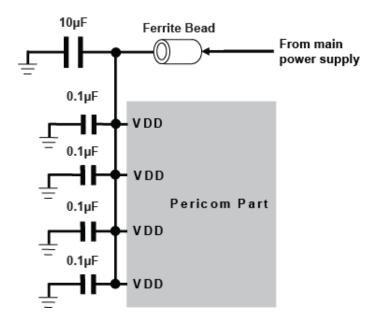
Typical Splitter Application





Power Supply Decoupling Circuit

It is recommended to put $0.1~\mu F$ decoupling capacitors on each VDD pins of our part, there are four $0.1~\mu F$ decoupling capacitors are put in Figure 1 with an assumption of only four VDD pins on our part, if there is more or less VDD pins on our Pericom parts, the number of $0.1~\mu F$ decoupling capacitors should be adjusted according to the actual number of VDD pins. On top of $0.1~\mu F$ decoupling capacitors on each VDD pins, it is recommended to put a $10~\mu F$ decoupling capacitor near our part's VDD, it is for stabilizing the power supply for our part. Ferrite bead is also recommended for isolating the power supply for our part and other power supplies in other parts of the circuit. But, it is optional and depends on the power supply conditions of other circuits.



Recommended Power Supply Decoupling Capacitor Diagram

Requirements on the De-coupling Capacitors

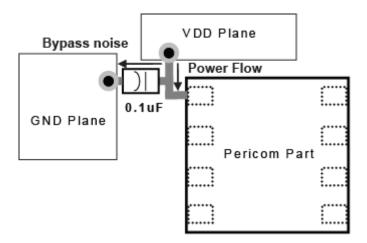
There is no special requirement on the material of the capacitors. Ceramic capacitors are generally being used with typically materials of X5R or X7R.

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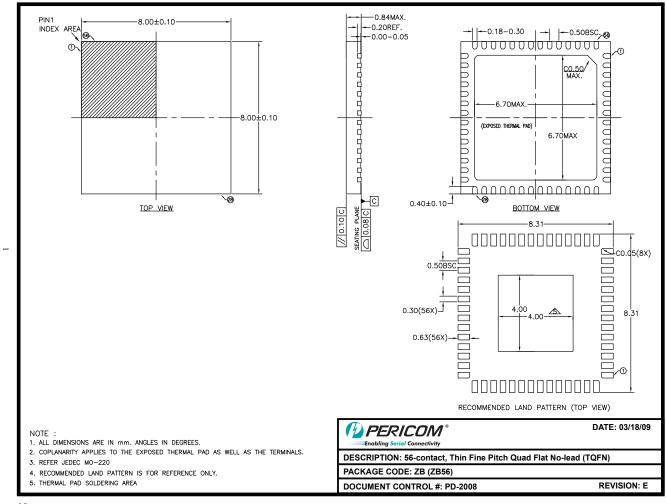
Layout and Decoupling Capacitor Placement Consideration

- Each 0.1 µF decoupling capacitor should be placed as close as possible to each VDD pin.
- VDD and GND planes should be used to provide a low impedance path for power and ground.
- Via holes should be placed to connect to VDD and GND planes directly.
- Trace should be as wide as possible
- Trace should be as short as possible.
- The placement of decoupling capacitor and the way of routing trace should consider the power flowing criteria.
- 10 μF Capacitor should also be placed closed to our part and should be placed in the middle location of 0.1 μF capacitors.
- Avoid the large current circuit placed close to our part; especially when it is shared the same VDD and GND planes.
 Since large current flowing on our VDD or GND planes will generate a potential variation on the VDD or GND of our part.



Decoupling Capacitor Placement Diagram

Package Mechanical: 56-pin TQFN (ZB56)



Note:

For latest package info, please check: http://www.pericom.com/products/packaging

Ordering Information

Ordering Code	Package Code	Package Description
PI3HDX412BDZBE	ZB	56-pin, Pb-free & Green TQFN, Source Termination Type

Notes:

Thermal characteristics can be found on the company web site at www.pericom.com/packaging/PI3HDX412B: Root Part Number

-D/E: D= Source Termination TMDS Top Mount Type, E = Source Termination TMDS Bottom Mount Type

-ZB = 56-pin TQFN Package Type

-E = Pb-free and Green

 $Adding \ an \ -X \ Suffix = Tape/Reel \ Type$

Related Products Information

Part Number	Product Description
PI3HDX414	HDMI 1.4b 3.4Gbps Splitter 1:4 with Signal Conditioning
PI3HDX1204	HDMI 2.0 Redriver for 6Gbps Application
PI3HDS20412	Wide Voltage Range DisplayPort & HDMI 2.0 Video Switch
PI3HDX511A	HDMI 1.4b 3.4Gbps Redriver and DP++ Level Shifter
PI3EQXDP1201	DisplayPort 1.2 Re-driver with Built-in AUX Listener
PI3VDP1430	Dual Mode DisplayPort to HDMI Level Shifter and Re-driver
PI3VDP3212	2-Lane DisplayPort1.2 Compliant Passive Switch
PI3VDP12412	4-Lane DisplayPort1.2 Compliant Passive Switch
PI3HDMI521	HDMI 1.4b 3.4Gbps 2:1 Switch/Re-driver with built-in ARC and Fast Switching support
PI3HDMI336	Active HDMI 3:1 Switch/Re-driver with I ² C control and ARC Transmitter

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